PRODUCT CHANGE NOTICE						
PART NUMBER(S):	PCN No.: 06-0130-14b					
Please see attachment.	DATE: June 23, 2006					
PART DESCRIPTION:						
Power Management and Interface Products – Change in Wafer Fabrication Site						
LEVEL OF CHANGE:						
[X] Level I, Customer Approval.	[ ] Level II, Customer Information.					
PRODUCT ATTRIBUTE AFFECTED:						
[ ] Material Change [ ] Design Change [X] Process Change	<ul><li>[ ] Data Sheet Change</li><li>[ ] Package Change</li><li>[ ] Packing / Shipping</li></ul>					
[X] Other, Explain: Wafer Fabrication Site Tran	nsfer					
DESCRIPTION OF CHANGE:  Announcing transfer of certain Power Management and Interface Products from Hillview wafer fabrication facility to wafer foundry EPISIL. See attached Product List no. 14b.						
REASON FOR CHANGE:						
Power Management and Interface products as listed are being transferred to external wafer foundry, due to cessation of operations of the Sipex Hillview Wafer Fabrication manufacturing site.						
FABRICATION PROCESS QUALIFICATION PRODUCT	CHARACTERIZATION COMPLETED AND					

COMPLETED (DATE): November 12, 2006

-Solved by

SAMPLES\* AVAILABLE (DATE): January 31, 2007

<sup>\*</sup> Samples representative of product from the Product Family being transferred.



PRODUCT CHANGE NOTICE					
EARLIEST DATE OF PRODUCTION SHIPMENTS: January 31, 2007					
EFFECTIVITY CHANGE DATE OR D	ATE CODE:	Work week assoc	iated wit	h earliest production shipment.	
[ ] STANDARD DISTRIBUTION			[X]	CUSTOM DISTRIBUTION	
PERSON TO CONTACT WITH QUES	STIONS:				
Fred Claussen					
VP Quality Assurance and Reliability Sipex Corporation Phone Number: 408-935-7644 FAX NUMBER: 408-935-7678					



## PRODUCT CHANGE NOTICE

PCN No.: 06-0130-14b

List 14b

SP332CT

SP332CT-L

SP332ET

SP332ET-L

SP333CT

SP333CT-L

SP333ET

SP333ET-L

SP334CA

SP334CA-L

SP334CT

SP334CT-L

SP334ET

SP334ET-L